



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## In re Application of:

Lunde et al.

**Serial No.:** 10/663,898

Filed: September 16, 2003

For: DYNAMIC INTEGRATED CIRCUIT CLUSTERS, MODULES INCLUDING

SAME AND METHODS OF

**FABRICATING** 

**Confirmation No.: 4518** 

Examiner: D. Nguyen

Group Art Unit: 2814

**Attorney Docket No.:** 2269-5457US

(01-1366.00/US)

**Notice of Allowance Mailed:** 

February 14, 2006

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| Date of Deposit with USPS:         | May 10, 2006  |
| Person making Deposit: Timothy I   | L. Palfreyman |

## AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 2 of this paper;

A Listing of the claims begins on page 4 of this paper; and

Remarks start at page 10 of this paper.